Please turn your camera and microphone OFF!



RIKEN International HPC Summer School 2025 -Toward Society 5.0(IHPCSS) Overview of the Class

https://www.r-ccs.riken.jp/en/outreach/schools/20250916-1001/

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- Target: Parallel FEM
- Supercomputers and Computational Science
- Overview of the Class
- Future Issues

This 5-day intensive course provides introduction to large-scale scientific computing using the most advanced massively parallel supercomputers. Topics cover:

- Parallel Finite-Element Method (FEM)
 - Finite-Element Method (FEM)
 - Message Passing Interface (MPI)
 - Parallel FEM using MPI and OpenMP
 - Parallel Numerical Algorithms for Iterative Linear Solvers
 - Parallel Numerical Libraries (e.g. PETSc)
- Introductions to AI/DNN (Deep Neural Network)

Several sample programs will be provided and participants can review the contents of lectures through hands-on-exercise/practices using Wisteria/BDEC-01 (Odyssey) with A64FX Processors (Fugaku Compatible System) at the University of Tokyo.

Finite-Element Method is widely-used for solving various types of realworld scientific and engineering problems, such as structural analysis, fluid dynamics, electromagnetics, and etc. This lecture course provides brief introduction to procedures of FEM for 1D/3D steady-state heat conduction problems with iterative linear solvers and to parallel FEM. Lectures for parallel FEM will be focused on design of data structure for distributed local mesh files, which is the key issue for efficient parallel FEM. Introduction to MPI (Message Passing Interface), which is widely used method as "de facto standard" of parallel programming, is also provided.

Solving large-scale linear equations with sparse coefficient matrices is the most expensive and important part of FEM and other methods for scientific computing, such as Finite-Difference Method (FDM) and Finite-Volume Method (FVM). Recently, families of Krylov iterative solvers are widely used for this process. In this course, details of implementations of parallel Krylov iterative methods are provided along with parallel FEM.

Moreover, lectures on programming for multicore architectures will be also given along with brief introduction to OpenMP and OpenMP/MPI Hybrid Parallel Programming Model.

Finally, lectures and hands-on for using PETSc library will be provide in the morning of the 5th day.

Rapid progress has been made in recent years in artificial intelligence technology, supported by the evolution of the Deep Neural Network (DNN) and the growing use of Al-specific hardware to support this technology. Understanding the basic mathematical background of DNNs, including the concept of Neural Networks as the basis of DNN, their capabilities as high-performance nonlinear approximation functions, and how to determine themselves efficiently, is not necessarily essential for Al users but is regarded as significant for researchers who are further advancing the field.

In this seminar, we will start with the basics of Neural Networks in a short lecture and then move on to approximating functions by backpropagation (i.e., the learning process in artificial intelligence), which is the underlying technology for the current DNNs. In addition, the seminar aims to deepen understanding through practical exercises such as image categorization using a simple program and the standard MNIST image database, identification of hand-written weird kana characters (namely Hentai-Gana;「変体仮名」in Japanese), and bridge to the use of higher-level AI frameworks and toolkits.

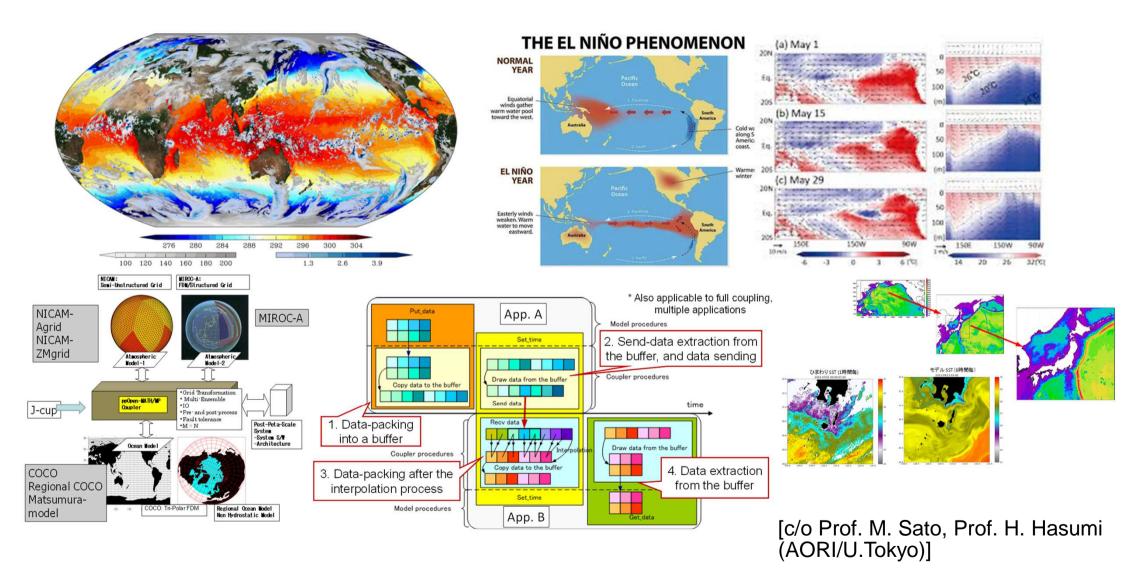
The following part of this material mainly focuses on the Parallel FEM in first 4-days

Motivation for Parallel Computing (and this class)

 Large-scale parallel computer enables fast computing in large-scale scientific simulations with detailed models.
 Computational science develops new frontiers of science and engineering.



Global Atmosphere-Ocean Coupled Simulations



Motivation for Parallel Computing (and this class)

- Large-scale parallel computer enables fast computing in large-scale scientific simulations with detailed models. Computational science develops new frontiers of science and engineering.
- Why parallel computing?
 - faster & larger
 - "larger" is more important from the view point of "new frontiers of science & engineering", but "faster" is also important.
 - + more complicated
 - Ideal: Scalable
 - Weak Scaling, Strong Scaling

Scalable, Scaling, Scalability

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- Solving N^x scale problem using N^x computational resources during same computation time
 - for large-scale problems: Weak Scaling, Weak Scalability
 - e.g. CG solver: more iterations needed for larger problems
- Solving a problem using N^x computational resources during 1/N computation time
 - for faster computation: Strong Scaling, Strong Scalability

Scientific Computing = SMASH

Science

<u>M</u>odeling

<u>A</u>lgorithm

Software

Hardware

- You have to learn many things.
- Collaboration (or Co-Design) will be important for future career of each of you, as a scientist and/or an engineer.
 - You have to communicate with people with different backgrounds.
 - It is more difficult than communicating with foreign scientists from same area.
- (Q): Your Department?

This Class ...

Science

<u>M</u>odeling

<u>A</u>lgorithm

Software

Hardware

- Parallel FEM using MPI and OpenMP
- Science: Heat Conduction
- Modeling: FEM
- Algorithm: Iterative Solvers etc.

 You have to know many components to learn FEM, although you have already learned each of these in undergraduate and high-school classes.

Road to Programming for "Parallel" Scientific Computing

Programming for Parallel Scientific Computing (e.g. Parallel FEM/FDM)

Programming for Real World Scientific Computing (e.g. FEM, FDM)

Programming for Fundamental Numerical Analysis (e.g. Gauss-Seidel, RK etc.)

Unix, Fortan, C etc.

Big gap here !!

The third step is important!

- How to parallelize applications?
 - How to extract parallelism ?
 - If you understand methods, algorithms, and implementations of the original code, it's easy.
 - "Data-structure" is important

- 4. Programming for Parallel Scientific Computing (e.g. Parallel FEM/FDM)
- 3. Programming for Real World Scientific Computing (e.g. FEM, FDM)
- 2. Programming for Fundamental Numerical Analysis (e.g. Gauss-Seidel, RK etc.)
 - 1. Unix, Fortan, C etc.

- How to understand the code?
 - Reading the application code !!
 - It seems primitive, but very effective.
 - In this class, "reading the source code" is encouraged.

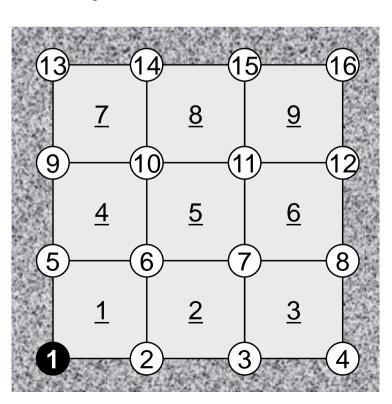
Finite-Element Method (FEM)



- One of the most popular numerical methods for solving PDE's.
 - elements (meshes) & nodes (vertices)
- Consider the following 2D heat transfer problem:

$$\lambda \left(\frac{\partial^2 T}{\partial x^2} + \frac{\partial^2 T}{\partial y^2} \right) + Q = 0$$

- 16 nodes, 9 bi-linear elements
- uniform thermal conductivity (λ =1)
- uniform volume heat flux (Q=1)
- T=0 at node 1
- Insulated boundaries



Galerkin FEM procedures



Apply Galerkin procedures to each element:

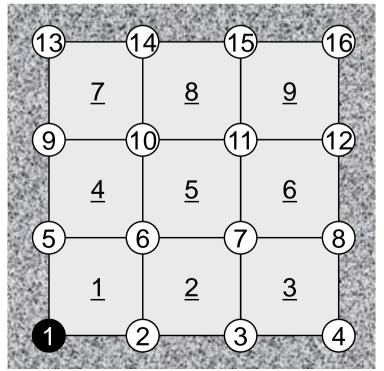
where
$$T = [N] \{\phi\}$$
 in each elem.

$$\int_{V} \left[N \right]^{T} \left\{ \lambda \left(\frac{\partial^{2} T}{\partial x^{2}} + \frac{\partial^{2} T}{\partial y^{2}} \right) + Q \right\} dV = 0 \qquad \{\phi\} : T \text{ at each vertex } [N] : \text{Shape function}$$

(Interpolation function)

 Introduce the following "weak form" of original PDE using Green's theorem:

$$-\int_{V} \lambda \left(\frac{\partial [N]^{T}}{\partial x} \frac{\partial [N]}{\partial x} + \frac{\partial [N]^{T}}{\partial y} \frac{\partial [N]}{\partial y} \right) dV \cdot \{\phi\}$$
$$+\int_{V} Q[N]^{T} dV = 0$$



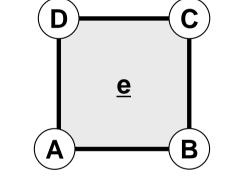
Element Matrix



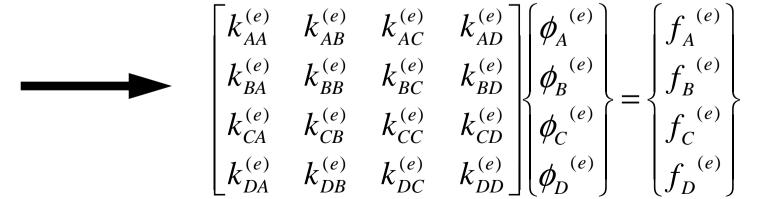
 Apply the integration to each element and form "element" matrix.

$$-\int_{V} \lambda \left(\frac{\partial [N]^{T}}{\partial x} \frac{\partial [N]}{\partial x} + \frac{\partial [N]^{T}}{\partial y} \frac{\partial [N]}{\partial y} \right) dV \cdot \{\phi\}$$

$$+ \int_{V} Q[N]^{T} dV = 0$$



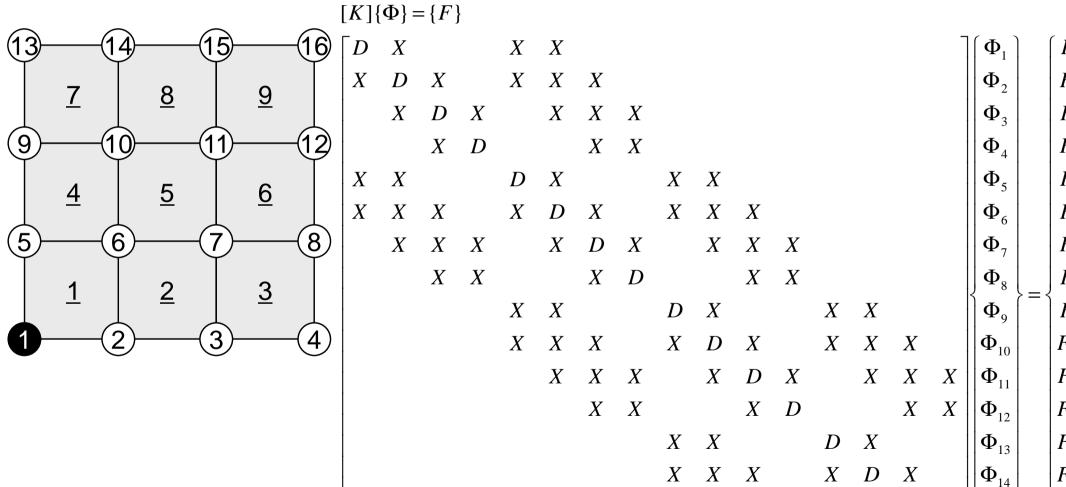
$$[k^{(e)}]\{\phi^{(e)}\} = \{f^{(e)}\}$$



Global (Overall) Matrix

Accumulate each element matrix to "global" matrix.



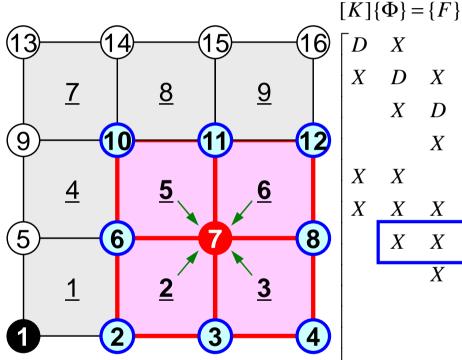


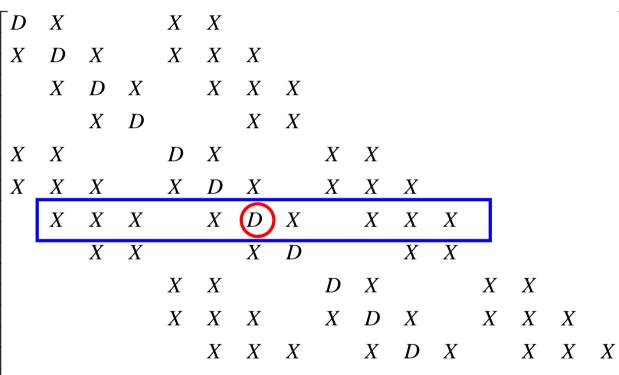
 \boldsymbol{X}

D

To each node ...

Effect of surrounding elem's/nodes are accumulated.





Coefficient matrix is very "sparse", many "0's"

Contributions from only neighbors

 Φ_{10}

 Φ_{11}

 Φ_{12}

 Φ_{13}

 Φ_{14}

 Φ_{15}

Solve the obtained global eqn's

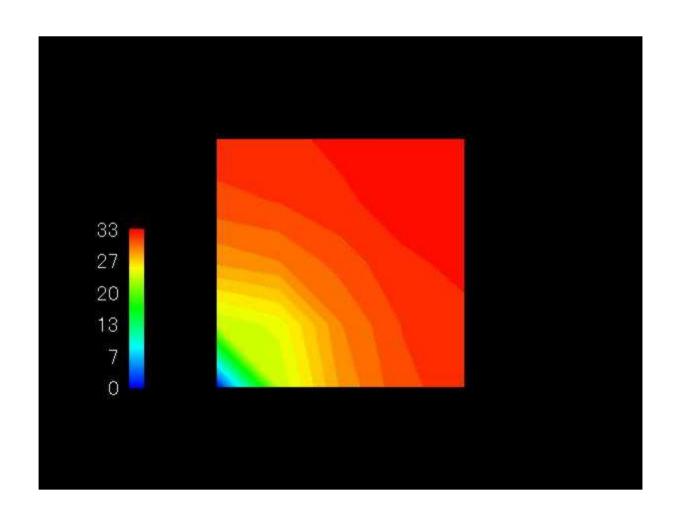
under certain boundary conditions $(\Phi_1=0 \text{ in this case})$



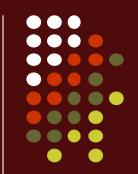
$\lceil D$	X			X	X										7	$\left(\Phi_{1}\right)$	F_1
X	D	X		X	X	X										$ \Phi_2 $	$F_2 \mid F_3 \mid$
	X	D	X		X	X	X									Φ_3	F_3
		X	D			X	X									Φ_4	F_4
X	X			D	X			X	X							Φ_5	F_5
X	X	X		X	D	X		X	X	X						$ \Phi_6 $	F_6
	\boldsymbol{X}	X	X		X	D	X		X	X	X					Φ_7	F_7
		X	X			X	D			X	X					Φ_{8}	F_8
				X	X			D	X			X	X			Φ_9	F_9
				X	X	X		X	D	X		X	X	X		$ \Phi_{10} $	F_{10}
					X	X	X		X	D	X		X	X	X	$ \Phi_{11} $	F_{11}
						X	X			X	D			X	X	$ \Phi_{12} $	$\left. egin{array}{c} F_{12} \ F_{13} \end{array} \right $
								X	X			D	X			Φ_{13}	F_{13}
								X	X	X		X	D	X		$ \Phi_{14} $	F_{14}
									X	X	X		X	D	X	$ \Phi_{15} $	F_{15}
										X	X			X	D floor	$\left[\Phi_{16}\right]$	F_{16}

Result ...





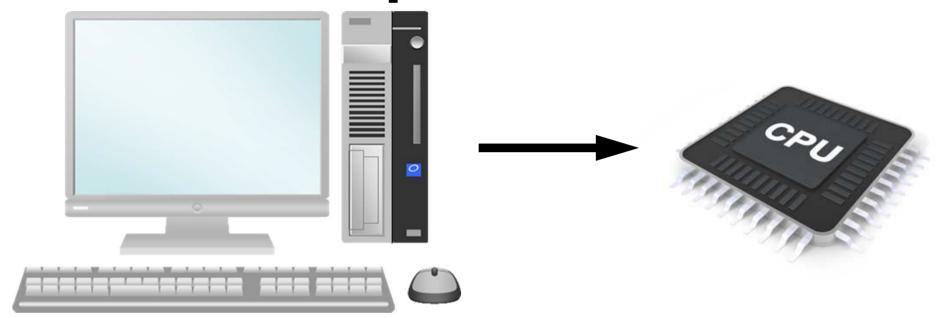
Features of FEM applications



- Typical Procedures for FEM Computations
 - Input/Output
 - Matrix Assembling
 - Linear Solvers for Large-scale Sparse Matrices
 - Most of the computation time is spent for matrix assembling/formation and solving linear equations.
- HUGE "indirect" accesses
 - memory intensive
- Local "element-by-element" operations
 - sparse coefficient matrices
 - suitable for parallel computing
- Excellent modularity of each procedure

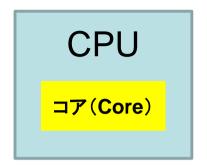
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Computer & CPU

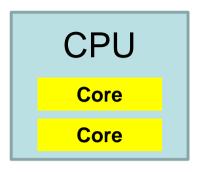


- Central Processing Unit (中央処理装置): CPU
- CPU's used in PC and Supercomputers are based on same architecture
- GHz: Clock Rate
 - Frequency: Number of operations by CPU per second
 - GHz -> 10⁹ operations/sec

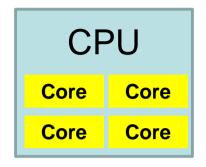
Multicore CPU



Single Core 1 cores/CPU



Dual Core 2 cores/CPU

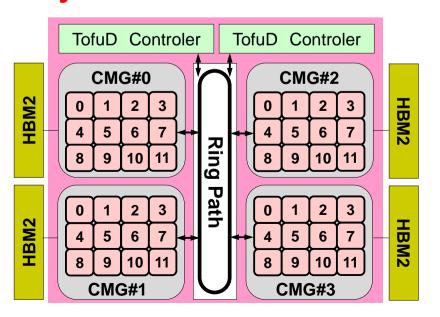


Quad Core 4 cores/CPU

- Core= Central part of CPU
- Multicore CPU's with 4-8 cores are popular
 - Low Power

- GPU: Manycore
 - $-O(10^3)-O(10^4)$ cores
- More and more cores
 - Parallel computing

Odyssey: 48-cores/node
 Fujitsu/ARM A64FX

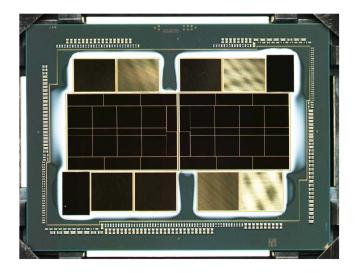


GPU/Accelerators

- GPU: Graphic Processing Unit
 - GPGPU: General Purpose GPU
 - $O(10^{3+}) cores$
 - High Memory Bandwidth
 - (was) cheap
 - NO stand-alone operations
 - Host CPU needed
 - Programming: CUDA, OpenACC etc.
- NVIDIA, AMD, Intel ...

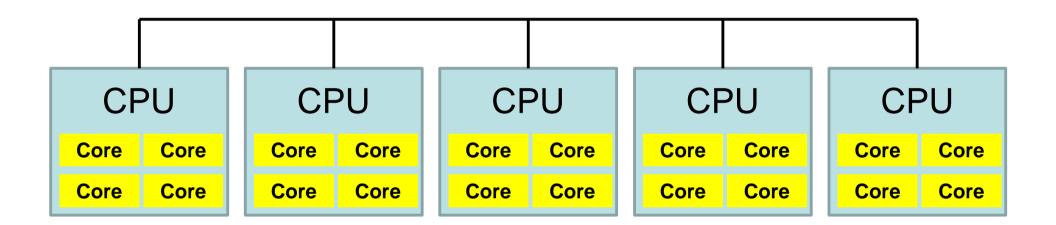




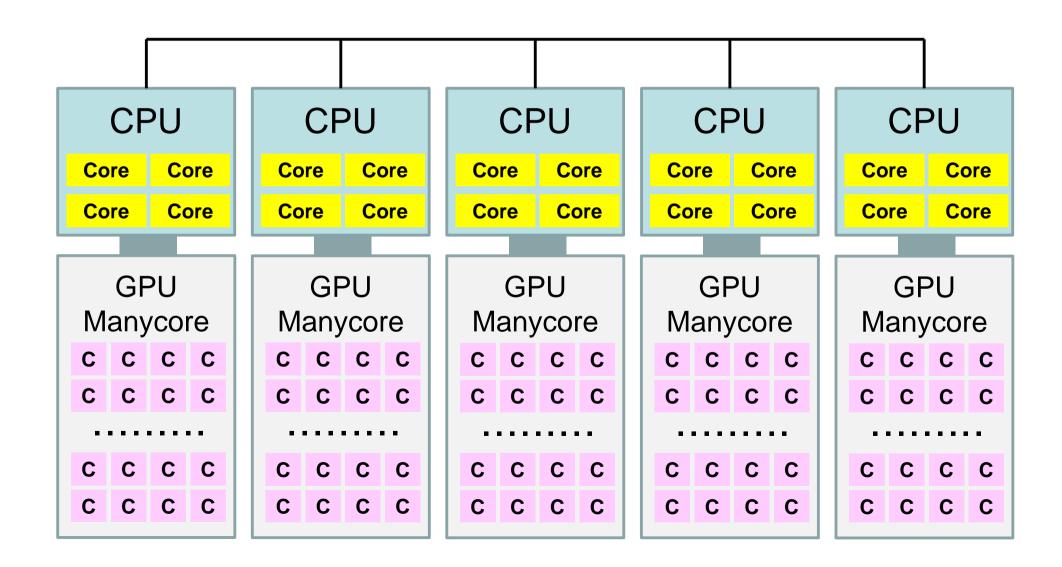


Parallel Supercomputers

Multicore CPU's are connected through network



Supercomputers with Heterogeneous/Hybrid Nodes



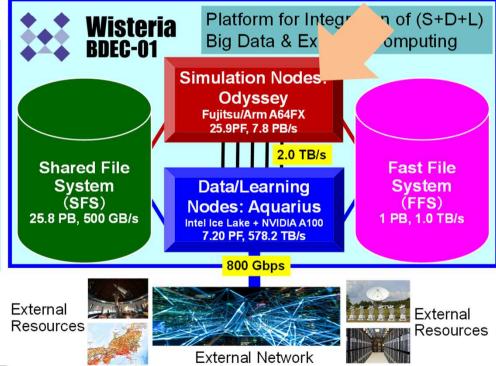
Performance of Supercomputers

- Performance of CPU: Clock Rate
- FLOPS (Floating Point Operations per Second)
 - Real Number
- Recent Multicore CPU
 - 4-8 FLOPS per Clock
 - (e.g.) Peak performance of a core with 3GHz
 - $3 \times 10^9 \times 4$ (or 8)=12(or 24) × 10^9 FLOPS=12(or 24)GFLOPS
 - 10⁶ FLOPS= 1 Mega FLOPS = 1 MFLOPS
 - 10⁹ FLOPS= 1 Giga FLOPS = 1 GFLOPS
 - 10¹² FLOPS= 1 Tera FLOPS = 1 TFLOPS
 - 10¹⁵ FLOPS= 1 Peta FLOPS = 1 PFLOPS
 - 10¹⁸ FLOPS= 1 Exa FLOPS = 1 EFLOPS

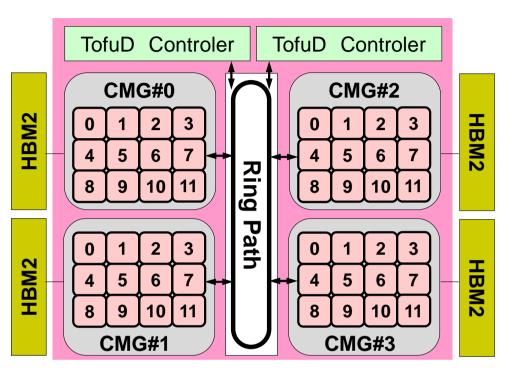
Wisteria/BDEC-01 (Odyssey)

- Operation starts on May 14, 2021
- 33.1 PF, 8.38 PB/sec by **Fujitsu**
 - ~4.5 MVA with Cooling, ~360m²
- 2 Types of Node Groups
 - Hierarchical, Hybrid, Heterogeneous (h3)
 - Simulation Nodes: Odyssey
 - Fujitsu PRIMEHPC FX1000 (A64FX), 25.9 PF
 - 7,680 nodes (368,640 cores), Tofu-D
 - General Purpose CPU + HBM
 - Commercial Version of "Fugaku"
 - Data/Learning Nodes: Aquarius
 - Data Analytics & Al/Machine Learning
 - Intel Xeon Ice Lake + NVIDIA A100, 7.2PF
 - 45 nodes (90x Ice Lake, 360x A100), IB-HDR
 - Some of the DL nodes are connected to external resources directly
- File Systems: SFS (Shared/Large) + FFS (Fast/Small)

The 1st BDEC System (Big Data & Extreme Computing)
Platform for Integration of (S+D+L)



A64FX Processor on Odyssey



Name	A64FX
Processor #	1 (48+ 2or4 Assistant
(Core #)	Cores)
Frequency	2.2 GHz
Peak Performance	3.3792 TFLOPS
Memory Size	32 GiB
Memory Bandwidth	1,024 GB/s
L1 Cache	64 KiB/core (Inst/Data)
L2 Cache	8 MiB/CMG

- 4 CMG's (Core Memory Group), 12 cores/CMG
 - 48 Cores/Node (Processor)
 - 2.2GHz × 32DP × 48= 3379.2 GFLOPS= 3.3792 TFLOPS
- NUMA Architecture (Non-Uniform Memory Access)
 - Each core of a CMG can access to the memory on other CMG's
 - Utilization of the local memory is more efficient

TOP 500 List

http://www.top500.org/

- Ranking list of supercomputers in the world
- Performance (FLOPS rate) is measured by "Linpack" which solves large-scale linear equations.
 - Since 1993
 - Updated twice a year (International Conferences in June and November)
- "Fugaku" has been #1 from June 2020 to Nov.2021 (4 times)
- "Frontier" is the 1st Exaflop System in June 2022
- Linpack
 - iPhone version is available

Projected Performance Development

 10^{19} = 10 ExaFlops

10¹⁸= 1 ExaFlops

10¹⁷=100 PetaFlops

10¹⁶= 10 PetaFlops

10¹⁵= 1 PetaFlops

10¹⁴=100 TeraFlops

 10^{13} = 10 TeraFlops

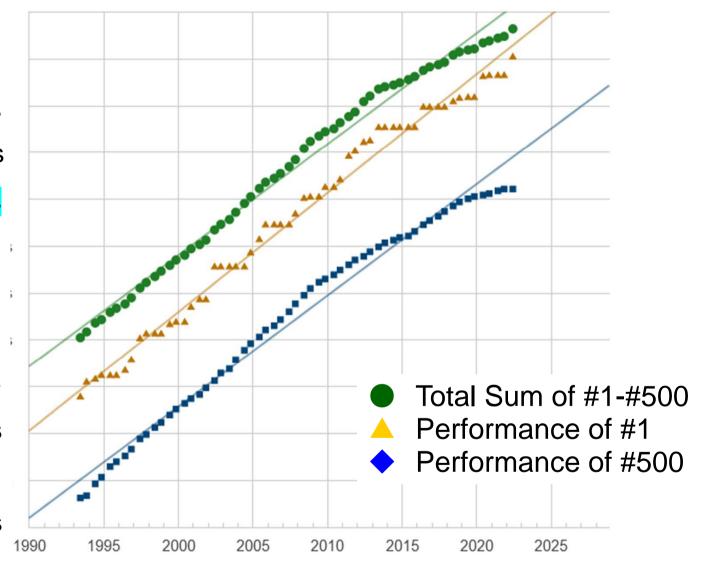
10¹²= 1 TeraFlops

10¹¹=100 GigaFlops

10¹⁰= 10 GigaFlops

10⁹= 1 GigaFlops

108=100 MegaFlops



65th TOP500 List (June, 2025)

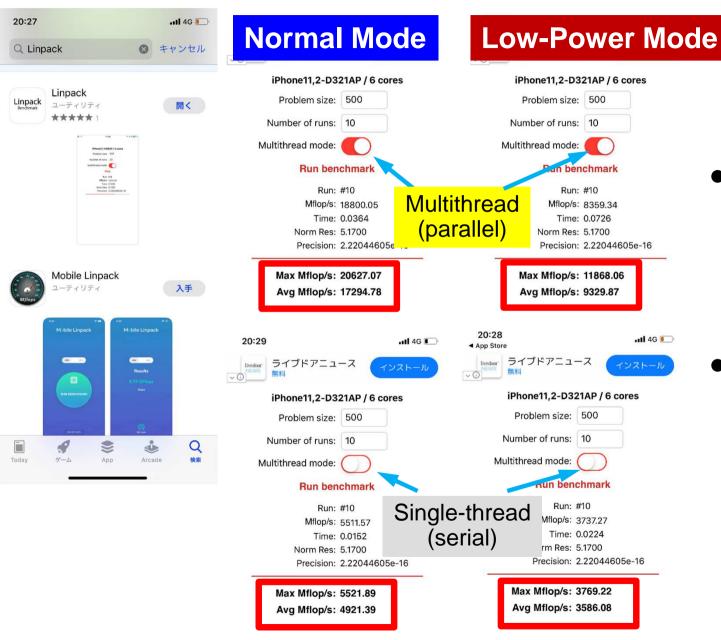
http://www.top500.org/

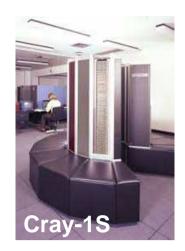
 R_{max} : Performance of Linpack (TFLOPS) R_{peak} : Peak Performance (TFLOPS),

Power: kW

	Site	Computer/Year Vendor	Cores	R _{max} (PFLOPS)	R _{peak} (PFLOPS)	GFLOPS/W	Power (kW)
1	El Capitan, 2024, USA DOE/NNSA/LLNL	HPE Cray EX255a, AMD 4th Gen EPYC 24C 1.8GHz, AMD Instinct MI300A, Slingshot-11, TOSS	11,039,616	1,742.00 (=1.742 EF)	2,746.38 63.4 %	58.99	29,581
2	<u>Frontier, 2021, USA</u> DOE/SC/Oak Ridge National Laboratory	HPE Cray EX235a, AMD Optimized 3 rd Gen. EPYC 64C 2GHz, AMD Instinct MI250X, Slingshot-11	9,066,176	1.353.00	2,055.72 65.8 %	54.98	24,607
3	<u>Aurora, 2023, USA</u> DOE/SC/Argonne National Laboratory	HPE Cray EX - Intel Exascale Compute Blade, Xeon CPU Max 9470 52C 2.4GHz, Intel Data Center GPU Max, Slingshot-11, Intel	9,264,128	1,012.00	1,980.01 51.1 %	26.15	38,698
4	JUPITER Booster, 2025, USA EuroHPC/FZJ	EVIDEN, BullSequana XH3000, GH Superchip 72C 3GHz, NVIDIA GH200 Superchip, Quad-Rail NVIDIA InfiniBand NDR200, RedHat Enterprise Linux	4,801,344	794,40	930.00 85.3 %	60.62	13,088
5	Eagle, 2023, USA Microsoft	Microsoft NDv5, Xeon Platinum 8480C 48C 2GHz, NVIDIA H100, NVIDIA Infiniband NDR	2,073,600	561.20	846.84 66.3 %		
6	HPC 6, 2024, Italy Eni S.p.A.	HPE Cray EX235a, AMD Optimized 3rd Generation EPYC 64C 2GHz, AMD Instinct MI250X, Slingshot-11, RHEL 8.9	3,143,520	477.90	606.97 66.3 %	56.48	8,461
7	Fugaku, 2020, Japan R-CCS, RIKEN	Fujitsu PRIMEHPC FX1000, Fujitsu A64FX 48C 2.2GHz, Tofu-D	7,630,848	442.01	537.21 82.3 %	14.78	29,899
8	Alps, 2024, Switzerland Swiss Natl. SC Centre (CSCS)	HPE Cray EX254n, NVIDIA Grace 72C 3.1GHz, NVIDIA GH200 Superchip, Slingshot-11	2,121,600	434.90	574.84 75.7 %	61.05	7,124
9	LUMI, 2023, Finland EuroHPC/CSC	HPE Cray EX235a, AMD Optimized 3 rd Gen. EPYC 64C 2GHz, AMD Instinct MI250X, Slingshot-11	2,752,704	379.70	531.51 71.4 %	53.43	7,107
10	Leonard, 2023, Italy EuroHPC/Cineca	EVIDEN, BullSequana XH2000, Xeon Platinum 8358 32C 2.6GHz, NVIDIA A100 SXM4 64GB, Quad-rail NVIDIA HDR100	1,824,768	241.20	181.49 78.7 %	32.19	7,494
15	ABCI 3.0, 2025, Japan AIST	HPE Cray XD670, Xeon Platinum 8558 48C 2.1GHz, NVIDIA H200 SXM5 141 GB, Infiniband NDR200, Rocky Linux 9	479,232	145.10	130.44 80.0 %	59.29	3,596
22	CHIE-3, 2024, Japan SoftBank, Corp.	NVIDIA DGX H100, Xeon Platinum 8480C 56C 2GHz, NVIDIA H100, Infiniband NDR400, Ubuntu 22.04.4 LTS	297,840	91.94	138.32 66.5 %		
24	CHIE-2, 2024, Japan SoftBank, Corp.	NVIDIA DGX H100, Xeon Platinum 8480C 56C 2GHz, NVIDIA H100, Infiniband NDR400, Ubuntu 22.04.4 LTS	297,840	89.78	138.32 64.9 %		
27	ABCI-Q, 2025, Japan AIST	Fujitsu, Supermicro SYS-221GE-TNHT-LCC, Intel Xeon Platinum 8558 48C 2.1GHz, NVIDIA H100 SXM5 80GB, Infiniband NDR, Rocky Linux 9.4	315,210	74.58	99.35 75.1 %	40.67	1,834
36	FPT, 2025, JAPAN FPT AI Factory	HPE, HGX H200, Xeon Platinum 8558 48C 2.1GHz, NVIDIA H200 SXM5 141 GB, Infiniband NDR400, Ubuntu 22.04.5 LTS	146,304	49.85	67.44 73.9 %		
37	Miyabi-G, 2024, Japan JCAHPC	Fujitsu, Supermicro ARS 111GL DNHR LCC, Grace Hopper Superchip 72C 3GHz, Infiniband NDR200, Rocky Linux	80,640	46.80	72.80 64.3 %	47.59	983
46	TSUBAME 4.0, 2024, Japan Institute of Science Tokyo	HPE Cray XD665, AMD EPYC 9654 96C 2.4GHz, NVIDIA H100 SXM5 94 GB, Infiniband NDR200	172,800	39.62	61.60 64.3 %	48.55	816
73	Wisteria/BDEC-01 (Odyssey), 2021, Japan U.Tokyo	Fujitsu PRIMEHPC FX1000, A64FX 48C 2.2GHz, Tofu D	368,640	22.12	25.95 85.2 %	15.07	1,468

Linpack on My iPhone XS





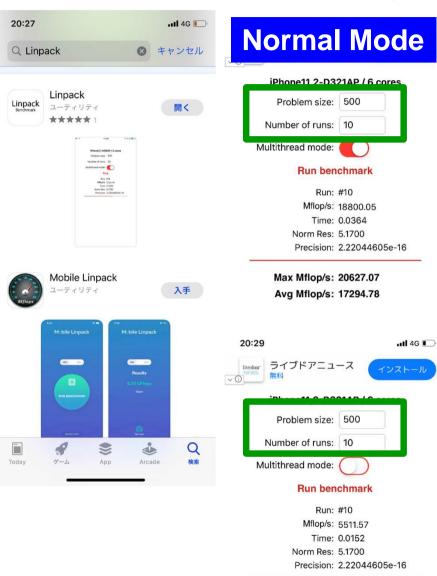
- Performance of my iPhone XS is about 20,000 Mflops
 - OBCX: 4.84 Tflops
- Cray-1S
 - Supercomputer of my company in 1985 with 80 Mflops
 - I do not know the price, but we had to pay 10 USD for 1 sec. computing!

Intro 36

Linpack on My iPhone XS

Max Mflop/s: 5521.89

Ava Mflop/s: 4921.39



Low-Power Mode

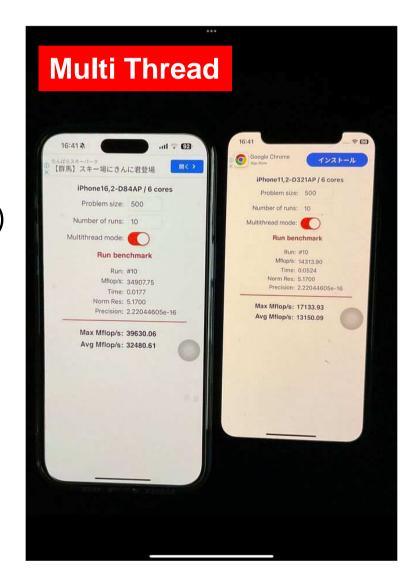


Avg Mflop/s: 3586.08

- You can change Problem size, and # of runs.
 - "Size=500" means linear equations Ax=b with 500 unknowns are solved
- Actually, problem size affects performance of computing so much !!

My New iPhone 15 Pro Max

- Normal Mode, n=500, 10 times
- XS(A12, D321AP, 2.49GHz)
 - Single Core: 4.88 GF
 - Multicore (6): 13.15 GF
 - 177 g
- 15-PM(A17 Pro, D84AP, 3.78GHz)
 - Single Core: 8.27 GF
 - Multicore (6): 32.48 GF
 - 221 g
- Ratio
 - Frequency: 1.51
 - Single Core: 1.70, Multicore: 2.47

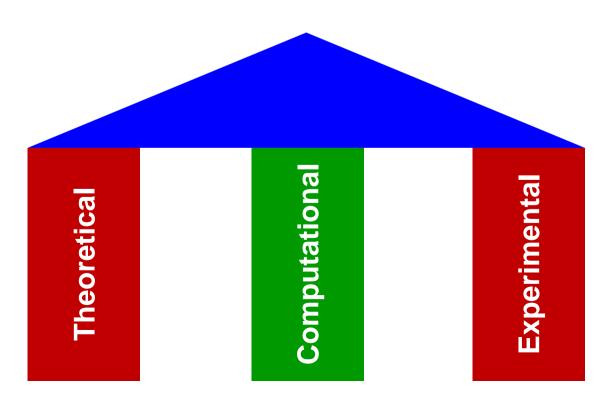


Computational Science

The 3rd Pillar of Science

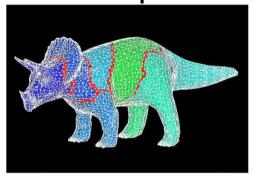
- Theoretical & Experimental Science
- Computational Science
 - The 3rd Pillar of Science
 - Simulations using Supercomputers



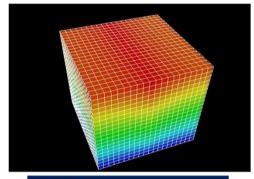


Methods for Scientific Computing

- Numerical solutions of PDE (Partial Diff. Equations)
- Grids, Meshes, Particles
 - Large-Scale Linear Equations
 - Finer meshes provide more accurate solutions



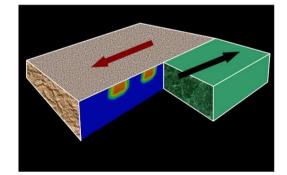
有限要素法 Finite Element Method FEM



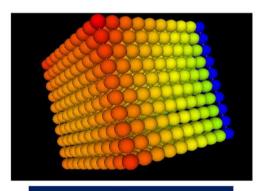
差分法 Finite Difference Method FDM



有限体積法 Finite Volume Method FVM



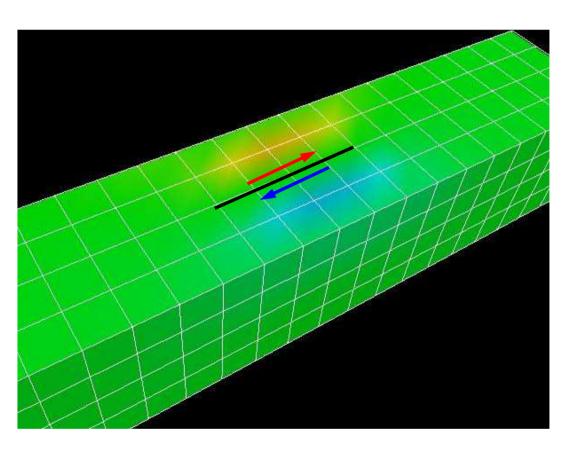
境界要素法 Boundary Element Method BEM

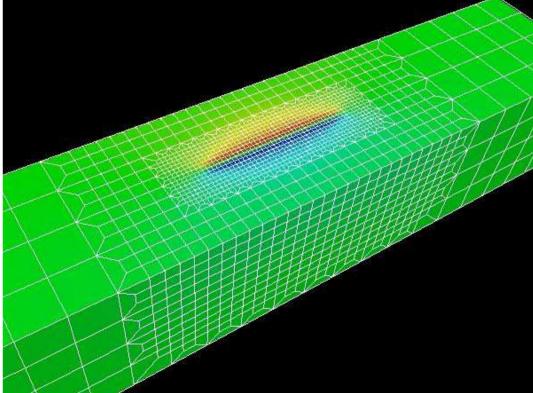


個別要素法 Discrete Element Method DEM

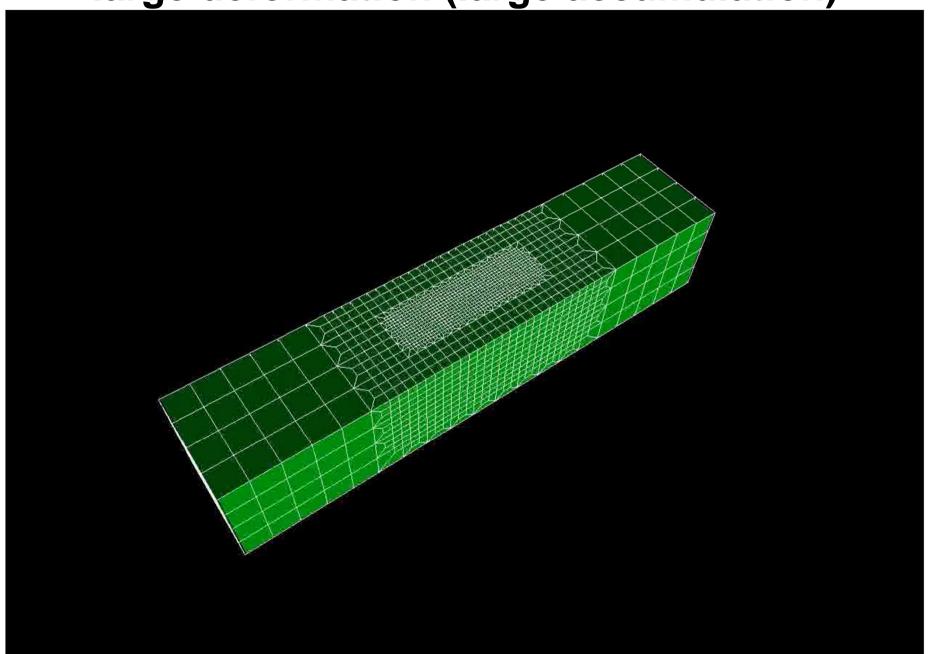
3D Simulations for Earthquake Generation Cycle San Andreas Faults, CA, USA

Stress Accumulation at Transcurrent Plate Boundaries

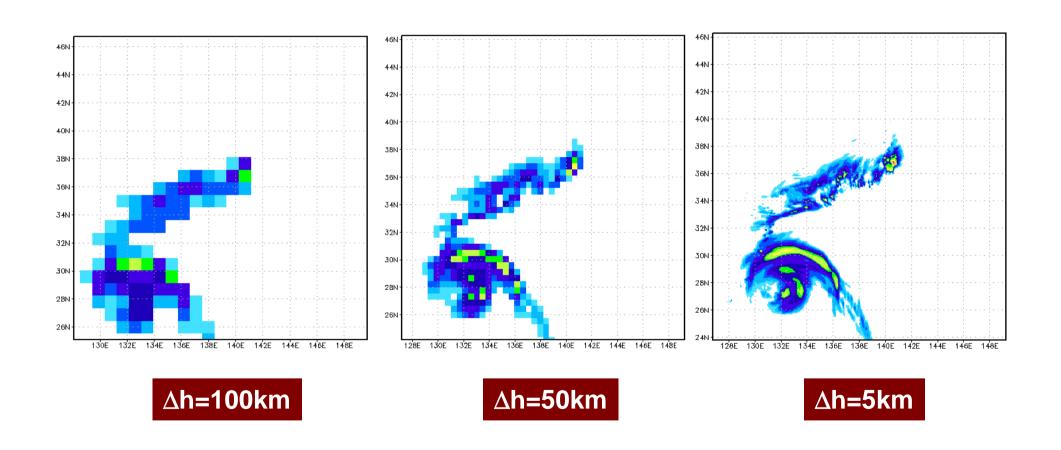


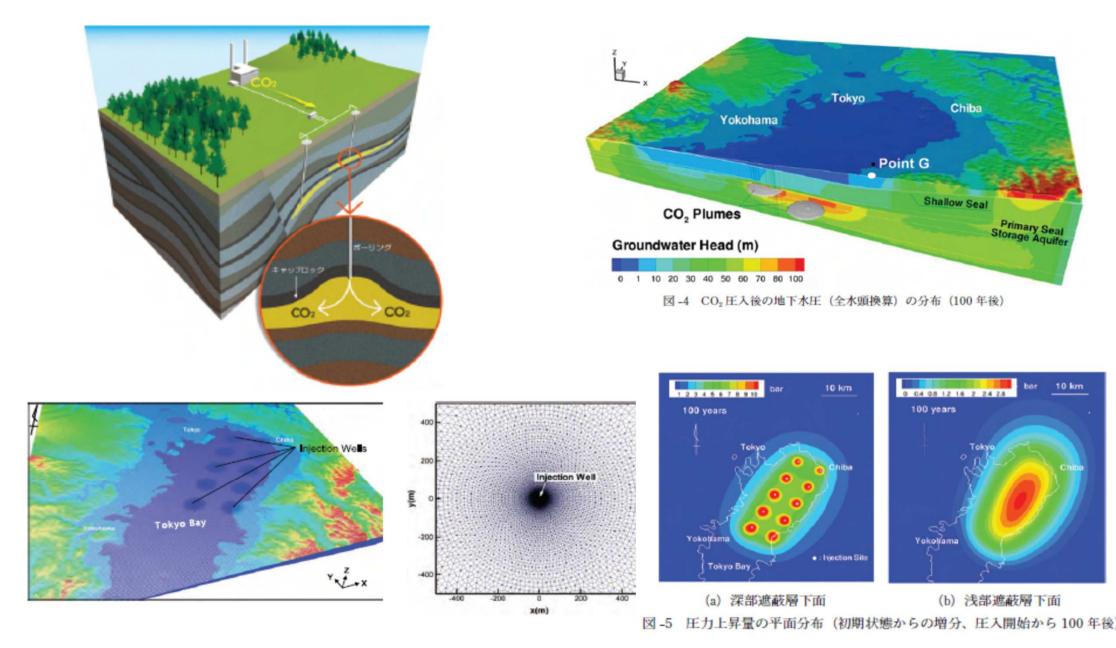


Adaptive FEM: High-resolution needed at meshes with large deformation (large accumulation)



Typhoon Simulations by FDM Effect of Resolution





[Dr. Hajime Yamamoto, Taisei]

- International/Interdisciplinary Collaborations
 - Taisei (Science, Modeling)
 - Lawrence Berkeley National Laboratory, USA (Modeling)
 - Information Technology Center, the University of Tokyo (Algorithm, Software)
 - JAMSTEC (Earth Simulator Center)
 (Software, Hardware)
 - NEC (Software, Hardware)
- 2010 Japan Geotechnical Society (JGS) Award

Science

<u>M</u>odeling

<u>Algorithm</u>

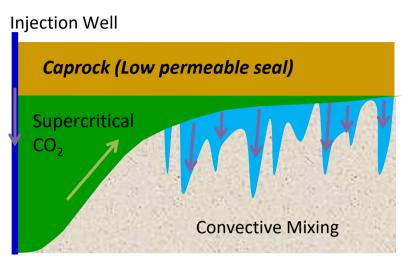
Software

Hardware

- Science
 - Behavior of CO₂ in supercritical state at deep reservoir
- PDE's
 - 3D Multiphase Flow (Liquid/Gas) + 3D Mass Transfer
- Method for Computation
 - TOUGH2 code based on FVM, and developed by Lawrence Berkeley National Laboratory, USA
 - More than 90% of computation time is spent for solving large-scale linear equations with more than 10⁷ unknowns
- Numerical Algorithm
 - Fast algorithm for large-scale linear equations developed by Information Technology Center, the University of Tokyo
- Supercomputer
 - Earth Simulator II (NEX SX9, JAMSTEC, 130 TFLOPS)
 - Oakleaf-FX (Fujitsu PRIMEHP FX10, U.Tokyo, 1.13 PFLOPS



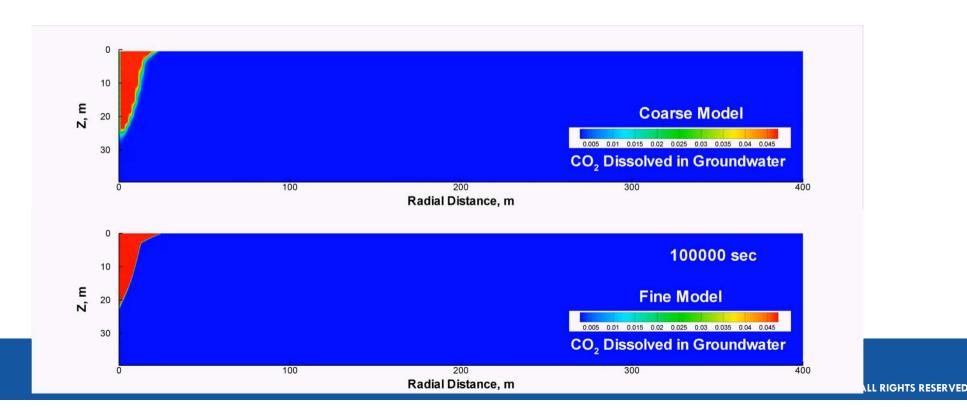
Diffusion-Dissolution-Convection Process



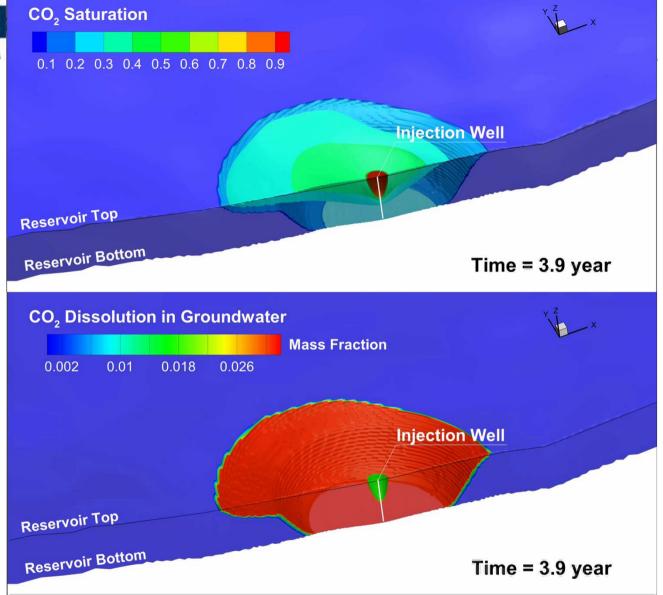
- Buoyant scCO₂ overrides onto groundwater
- Dissolution of CO₂ increases water density
- Denser fluid laid on lighter fluid
- Rayleigh-Taylor instability invokes convective mixing of groundwater

The mixing significantly enhances the CO₂ dissolution into groundwater, resulting in more stable storage

Preliminary 2D simulation (Yamamoto et al., GHGT11) [Dr. Hajime Yamamoto, Taisei]







Density convections for 1,000 years:

Flow Model

Only the far side of the vertical cross section passing through the injection well is depicted.

Reservoir Condition

• Permeability: 100 md

• Porosity: 20%

• Pressure: 3MPa

Temperature: 100°C

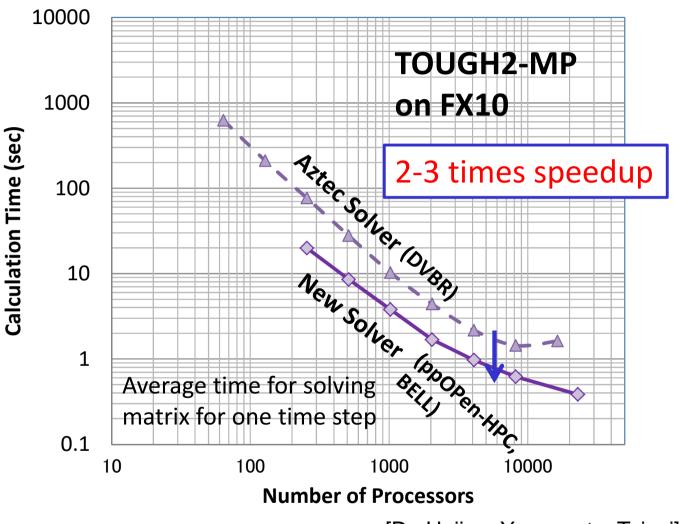
Salinity: 15wt%

[Dr. Hajime Yamamoto, Taisei]

- The meter-scale fingers gradually developed to larger ones in the field-scale model
- Huge number of time steps (> 10⁵) were required to complete the 1,000-yrs simulation
- Onset time (10-20 yrs) is comparable to theoretical (linear stability analysis, 15.5yrs)

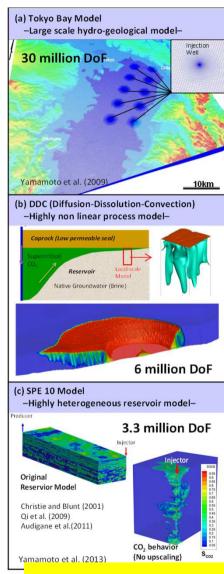


30 million DoF (10 million grids \times 3 DoF/grid node)



[Dr. Hajime Yamamoto, Taisei]

Fujitsu FX10(Oakleaf-FX), 30M DOF: 2x-3x improvement



* 3D Multiphase Flow (Liquid/Gas) + 3D Mass Transfer

Motivation for Parallel Computing, again

- Large-scale parallel computer enables fast computing in large-scale scientific simulations with detailed models.
 Computational science develops new frontiers of science and engineering.
- Why parallel computing?
 - faster
 - larger
 - "larger" is more important from the view point of "new frontiers of science & engineering", but "faster" is also important.
 - + more complicated
 - Ideal: Scalable
 - Weak Scaling, Strong Scaling

- Target: Parallel FEM
- Supercomputers and Computational Science
- Overview of the Class
- Future Issues

Information

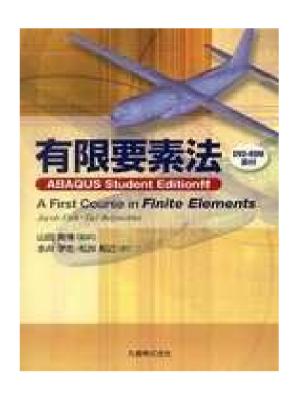
- Slack Channel
 - https://rikenihpcss2024.slack.com/
- Class Materials
 - http://nkl.cc.u-tokyo.ac.jp/2024-RIKEN-IHPCSS/

Prerequisites

- Knowledge and experiences in fundamental methods for numerical analysis (e.g. Gaussian elimination, SOR)
- Knowledge and experiences in Unix/Linux
 - Essential for using Supercomputers
 - Google "Introduction to Unix", "Introduction to Linux"
 - -cd, ls, cp, mv, rm, scp
 - Editor: vi, emacs etc.
- Experiences in programming using FORTRAN or C

	September 16 (Tue)	
09:00-12:00	Introduction, 1D FEM	Nakajima
13:30-17:00	3D FEM	Nakajima
17:00-18:00	Fugaku Virtual Tour, Overview of Fugaku	Imamura
	September 17 (Wed)	
09:00-12:00	Road to Parallel FEM, Introduction to MPI (1/4)	Nakajima
13:30-18:00	Introduction to MPI (2/4)	Nakajima
	September 29 (Mon)	
09:00-12:00	Introduction to MPI (3/4)	Nakajima
13:30-15:00	Introduction to MPI (4/4)	Nakajima
15:00-18:00	Parallel FEM (1/2)	Nakajima
	September 30 (Tue)	
09:00-12:00	Parallel FEM (2/2)	Nakajima
13:30-15:00	Parallel Visualization	Nakajima
15:00-18:00	OpenMP/MPI Hybrid, CC-Overlapping	Nakajima
	October 01 (Wed)	
09:00-12:00	PETSc	Imamura
13:30-17:30	CNN	Imamura
17:30-	Closing	All

References



- Fish, Belytschko, A First Course in Finite Elements, Wiley, 2007
 - Japanese version is also available
 - "ABAQUS Student Edition" included
- Smith et al., Programming the Finite Element Method (4th edition), Wiley, 2004
 - Parallel FEM included
- Hughes, The Finite Element Method: Linear Static and Dynamic Finite Element Analysis, Dover, 2000

- Target: Parallel FEM
- Supercomputers and Computational Science
- Overview of the Class
- Future Issues

Technical Issues: Future of Supercomputers

- Power Consumption
 - 1MW=1,000kW~ 1M+ USD/yr, 200M+ JPY/yr
- Reliability, Fault Tolerance, Fault Resilience
- Scalability (Parallel Performance)

Key-Issues towards Appl./Algorithms on Exa-Scale Systems

Jack Dongarra (ORNL/U. Tennessee) at ISC 2013

- Hybrid/Heterogeneous Architecture
 - Multicore + GPU/Manycores (Intel MIC/Xeon Phi)
 - Data Movement, Hierarchy of Memory
- Communication/Synchronization Reducing Algorithms
- Mixed Precision Computation
- Auto-Tuning/Self-Adapting
- Fault Resilient Algorithms
- Reproducibility of Results

Supercomputers with Heterogeneous/Hybrid Nodes

